

DS4150-5.5

DSF8045SK

FAST RECOVERY DIODE

APPLICATIONS

■ Snubber Diode For GTO Applications.

KEY PARAMETERS				
V_{RRM}	4500V			
I _{F(AV)}	430A			
I _{FSM}	3500A			
Q,	440 μC			
tŗ	3.07 μs			

FEATURES

- Double side cooling.
- High surge capability.
- Low recovery charge.

VOLTAGE RATINGS

Type Number	Repetitive Peak Reverse Voltage V _{RRM} V	Conditions
DSF8045SK45	4500	$V_{RSM} = V_{RRM} + 100V$
DSF8045SK44	4400	
DSF8045SK43	4300	
DSF8045SK42	4200	
DSF8045SK41	4100	
DSF8045SK40	4000	

Lower voltage grades available.

CURRENT RATINGS



Outline type code: K. See package outlines for further information.

Symbol	Parameter	Conditions	Max.	Units			
Double Sid	Double Side Cooled						
I _{F(AV)}	Mean forward current	Half wave resistive load, $T_{case} = 65^{\circ}C$	430	A			
I _{F(RMS)}	RMS value	$T_{case} = 65^{\circ}C$	680	A			
I _F	Continuous (direct) forward current	$T_{case} = 65^{\circ}C$	600	А			
Single Side Cooled (Anode side)							
I _{F(AV)}	Mean forward current	Half wave resistive load, $T_{case} = 65^{\circ}C$	285	А			
I _{F(RMS)}	RMS value	$T_{case} = 65^{\circ}C$	445	A			
I _F	Continuous (direct) forward current	$T_{case} = 65^{\circ}C$	380	A			

SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I _{FSM}	Surge (non-repetitive) forward current	10ms half sine; with 0% V _{RRM} T _i = 150°C	3.5	kA
l²t	I ² t for fusing		61.25 x 10 ³	A ² s
I _{FSM}	Surge (non-repetitive) forward current	10mc half cine: with $50%$ V T = $150%$	2.8	kA
l²t	I ² t for fusing	10ms half sine; with 50% V_{RRM} , $T_j = 150^{\circ}C$	39.2 x 10 ³	A²s

THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions		Min.	Max.	Units
R _{th(j-c)} Thermal resistar		Double side cooled	dc	-	0.048	°C/W
	Thermal resistance - junction to case	Single side cooled	Anode dc	-	0.09	°C/W
			Cathode dc	-	0.103	°C/W
	Thermal registeres, ease to bestainly	Clamping force 8.0kN with mounting compound	Double side	-	0.01	°C/W
K _{th(c-h)}	R _{th(c-h)} Thermal resistance - case to heatsink		Single side	-	0.02	°C/W
T _{vj}	Virtual junction temperature	Forward (conducting)		-	150	°C
T _{stg}	Storage temperature range			-55	175	°C
-	Clamping force			7.0	9.0	kN

CHARACTERISTICS

Symbol	Parameter	Conditions	Тур.	Max.	Units
V _{FM}	Forward voltage	At 1000A peak, T _{case} = 25°C	-	4.0	V
I _{RRM}	Peak reverse current	At V_{RRM} , $T_{\text{case}} = 150^{\circ}\text{C}$	-	50	mA
t _{rr}	Reverse recovery time		-	3.07	μs
Q _{RA1}	Recovered charge (50% chord)	I _F = 1000A, di _{RR} /dt = 100A/μs	-	440	μC
I _{RM}	Reverse recovery current	T _{case} = 150°C, V _R = 100V	-	240	A
к	Soft factor	-	-	-	-
V _{TO}	Threshold voltage	At $T_{vj} = 150^{\circ}C$	-	1.7	V
r _T	Slope resistance	At $T_{vj} = 150^{\circ}C$	-	2.1	mΩ
V _{FRM}	Forward recovery voltage	di/dt = 1000A/µs, T _j = 125°C	-	300	V

DEFINITION OF K FACTOR AND $\mathbf{Q}_{_{\mathrm{RA1}}}$



CURVES







Fig.2 Maximum (limit) forward characteristics



Fig.3 Transient forward voltage vs rate of rise of forward current







Fig.6 Maximum (limit) transient thermal impedance - junction to case - (°C/W)

PACKAGE DETAILS - K

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





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